

DMTH6006LPSWQ

60V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D T _C = +25°C (Note 9)
60V	6.5mΩ @ V _{GS} = 10V	100A
	10mΩ @ V _{GS} = 4.5V	81.6A

Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- **Engine Management Systems**
- **Body Control Electronics**
- **DC-DC Converters**

Features

- Rated to +175°C --- Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production-Ensures More Reliable and Robust End Application
- Low R_{DS(ON)}—Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH6006LPSWQ is suitable for automotive applications requiring specific change control and is AEC-Q101 qualified, is PPAP capable, and is manufactured in IATF16949:2016 certified facilities.

Mechanical Data

- Case: PowerDl[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @3

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Weight: 0.097 grams (Approximate)

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Internal Schematic



Ordering Information (Note 4)

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	Part Number	Case	Packaging		
	DMTH6006LPSWQ-13	PowerDI5060-8 (SWP) (Type Q)	2500/Tape & Reel		
Notes:	Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.				

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

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3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



☐]] = Manufacturer's Marking TH6006LSW = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 19 = 2019) WW = Week Code (01 to 53)

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Top View

Pin Configuration



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	60	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current, V_{GS} = 10V (Note 5)	T _A = +25°C T _A = +100°C	ID	17.2 12.1	А
Continuous Drain Current, V_{GS} = 10V (Notes 6 & 9)	T _C = +25°C T _C = +100°C	ID	100 71.6	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	400	А	
Maximum Continuous Body Diode Forward Current (Note	Is	100	А	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cy	I _{SM}	400	А	
Avalanche Current, L=0.1mH		I _{AS}	28.5	А
Avalanche Energy, L=0.1mH		E _{AS}	40.7	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.88	W
Thermal Resistance, Junction to Ambient (Note 5)		R _{ƏJA}	52	°C/W
Total Power Dissipation (Note 6)	T _C = +25°C	PD	100	W
Thermal Resistance, Junction to Case (Note 6)		R _{eJC}	1.5	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	eysei		.,,,,	max	Unit		
Drain-Source Breakdown Voltage	BV _{DSS}	60	—	_	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}		—	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS		—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)						·	
Gate Threshold Voltage	V _{GS(TH)}	1.2	—	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance		-	4.9	6.5	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	7.1	10	11122	V _{GS} = 4.5V, I _D = 10A	
Diode Forward Voltage	V _{SD}		0.8	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)	•						
Input Capacitance	Ciss		2162	_		$V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz	
Output Capacitance	Coss	_	761	_	pF		
Reverse Transfer Capacitance	C _{rss}		58	_			
Gate Resistance	Rg	-	0.7	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	18.1	_		V _{DS} = 30V, I _D = 20A	
Total Gate Charge (V _{GS} = 10V)	Qg	_	34.9	_	nC		
Gate-Source Charge	Q _{gs}	—	6.1	_	nc		
Gate-Drain Charge	Q _{gd}	_	7.3	_			
Turn-On Delay Time	t _{D(ON)}	_	6.0	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_D = 20A, R_g = 3\Omega$	
Turn-On Rise Time	t _R	_	5.4	_	20		
Turn-Off Delay Time	t _{D(OFF)}	_	20.4	_	ns		
Turn-Off Fall Time	tF		7.8	_		-	
Body Diode Reverse Recovery Time	t _{RR}	-	35.8	—	ns	$L_{-} = 200$ di/dt = 1000/up	
Body Diode Reverse Recovery Charge	Q _{RR}	_	40.2	_	nC	I _F = 20A, di/dt = 100A/μs	

5. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).

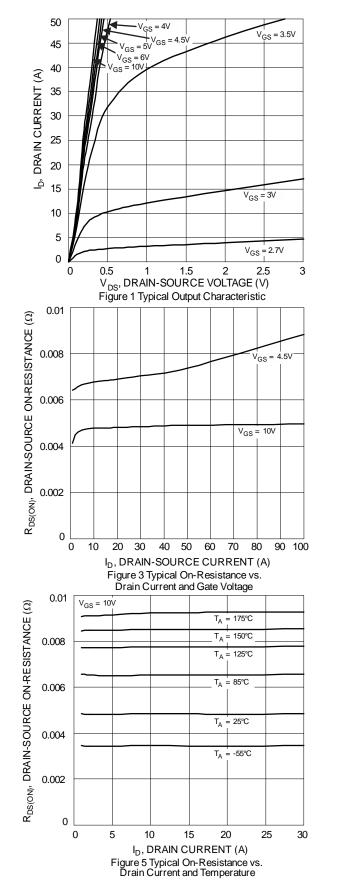
7. Short duration pulse test used to minimize self-heating effect.

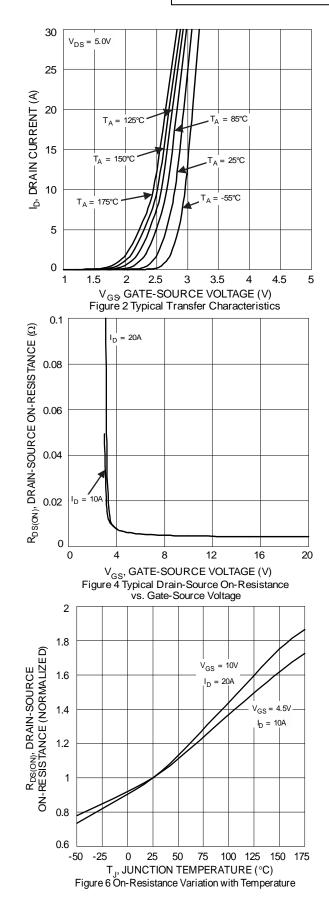
B. Guaranteed by design. Not subject to product testing.
Limited by package.

Notes:



DMTH6006LPSWQ

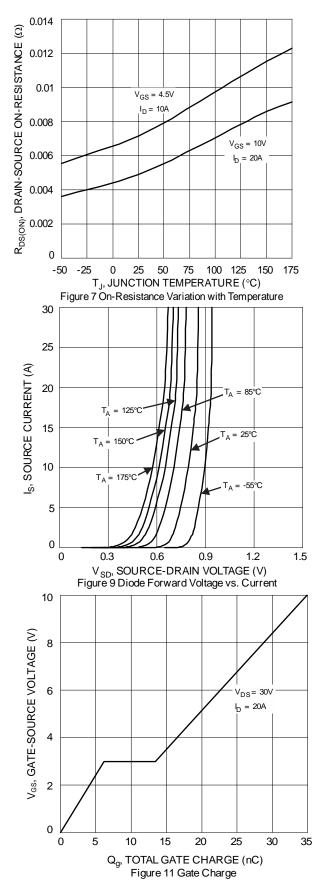


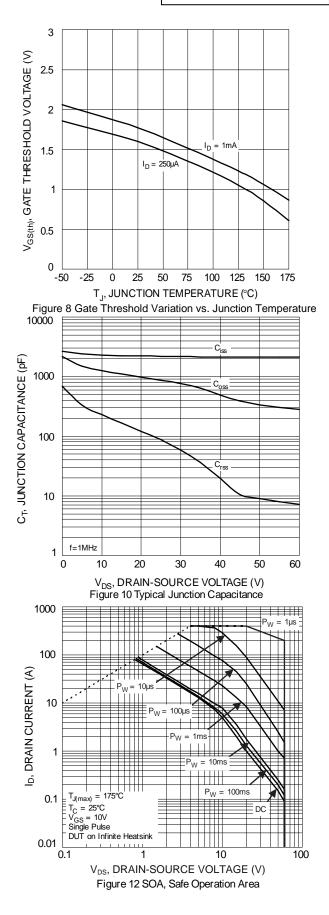


DMTH6006LPSWQ Document number: DS41360 Rev.2 - 2



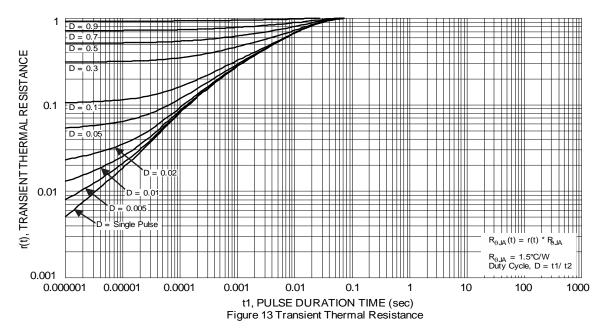
DMTH6006LPSWQ





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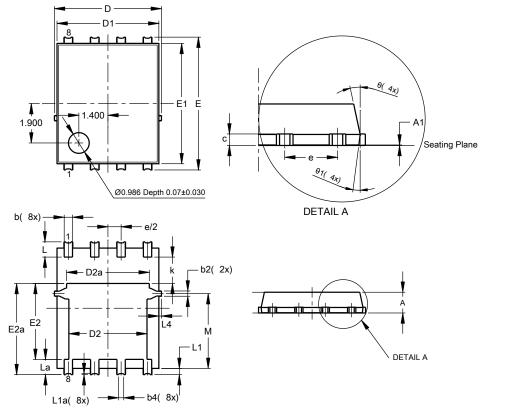






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



PowerDI5060-8 (SWP) (Type Q)

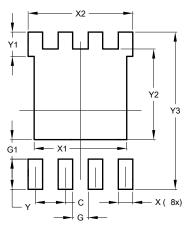
(Type Q)					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	().25REF	-		
С	0.230	0.330	0.277		
D	-	.15 BS0	0		
D1	4.70	5.10	4.90		
D2	3.56	3.96	3.76		
D2a	3.78	4.18	3.98		
E	6.40 BSC				
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1	.27BSC)		
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
L1a	0	.050RE	F		
L4	0.025	0.225	0.125		
М	3.205	4.005	3.605		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

PowerDI5060-8 (SWP)

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type Q)



Dimensions	Value		
	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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